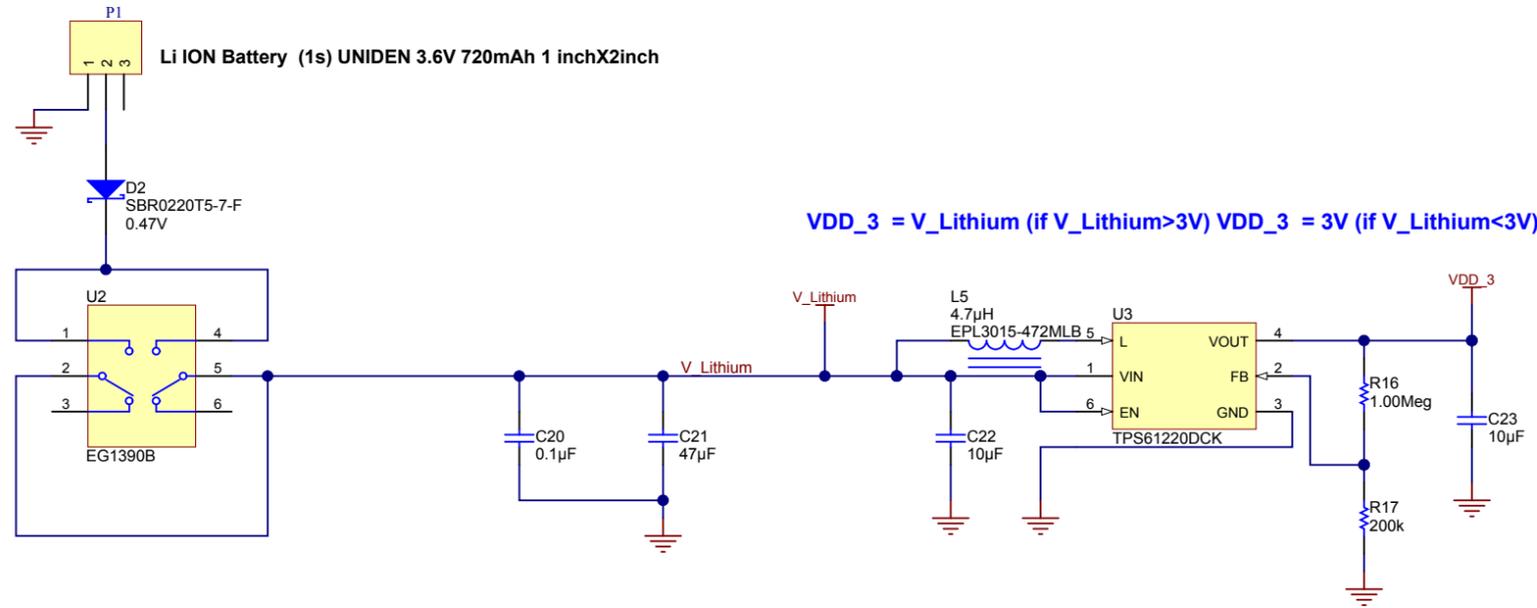


Power Section



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Number: SAT0015	Rev: E2	Designed for: Public Release	Mod. Date: 12/13/2013
SVN Rev: Not in version control	Assembly Variant: 001	Project Title: SAT0015_E2	Sheet Title: Power
Drawn By: Ajinder Singh	File: Power_SchDoc	Sheet: 1 of 1	Size: B
Engineer: Ajinder Singh	Contact: http://www.ti.com/support		



PCB Number: SAT0015
PCB Rev: E2

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ZZ2

Assembly Note

These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3

Assembly Note

These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4

Assembly Note

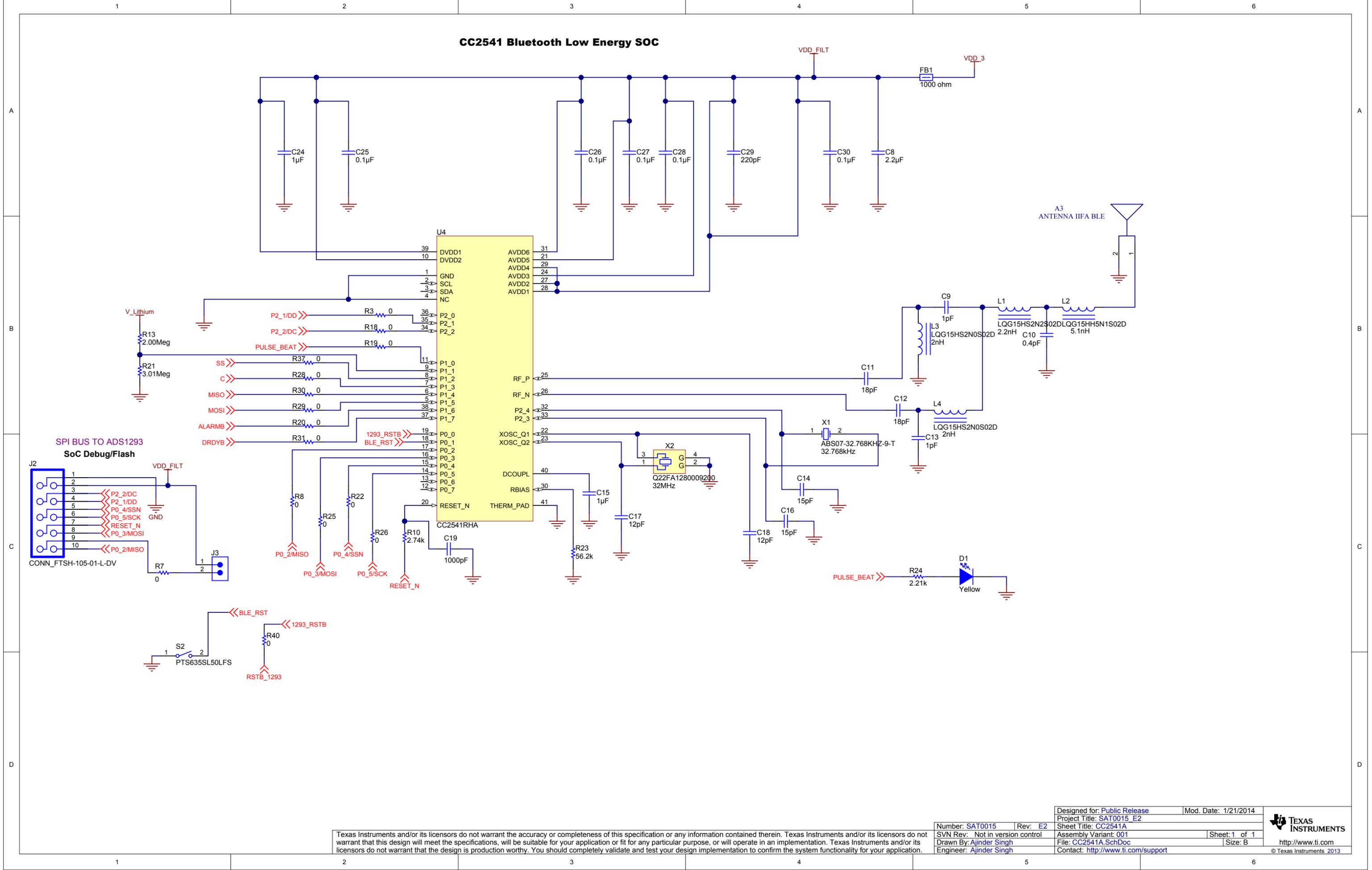
These assemblies must comply with workmanship standards IPC-A-610 Class 2., unless otherwise specified.

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Number: SAT0015		Rev: E2	Designed for: Public Release	Mod. Date: 9/9/2013
SVN Rev: Not in version control		Project Title: SAT0015_E2		
Drawn By:		Assembly Variant: 001	Sheet: 1 of 1	
Engineer: Ajinder Singh		File: Hardware_ANSI-B_SchDoc	Size: B	
		Contact: http://www.ti.com/support		



CC2541 Bluetooth Low Energy SOC



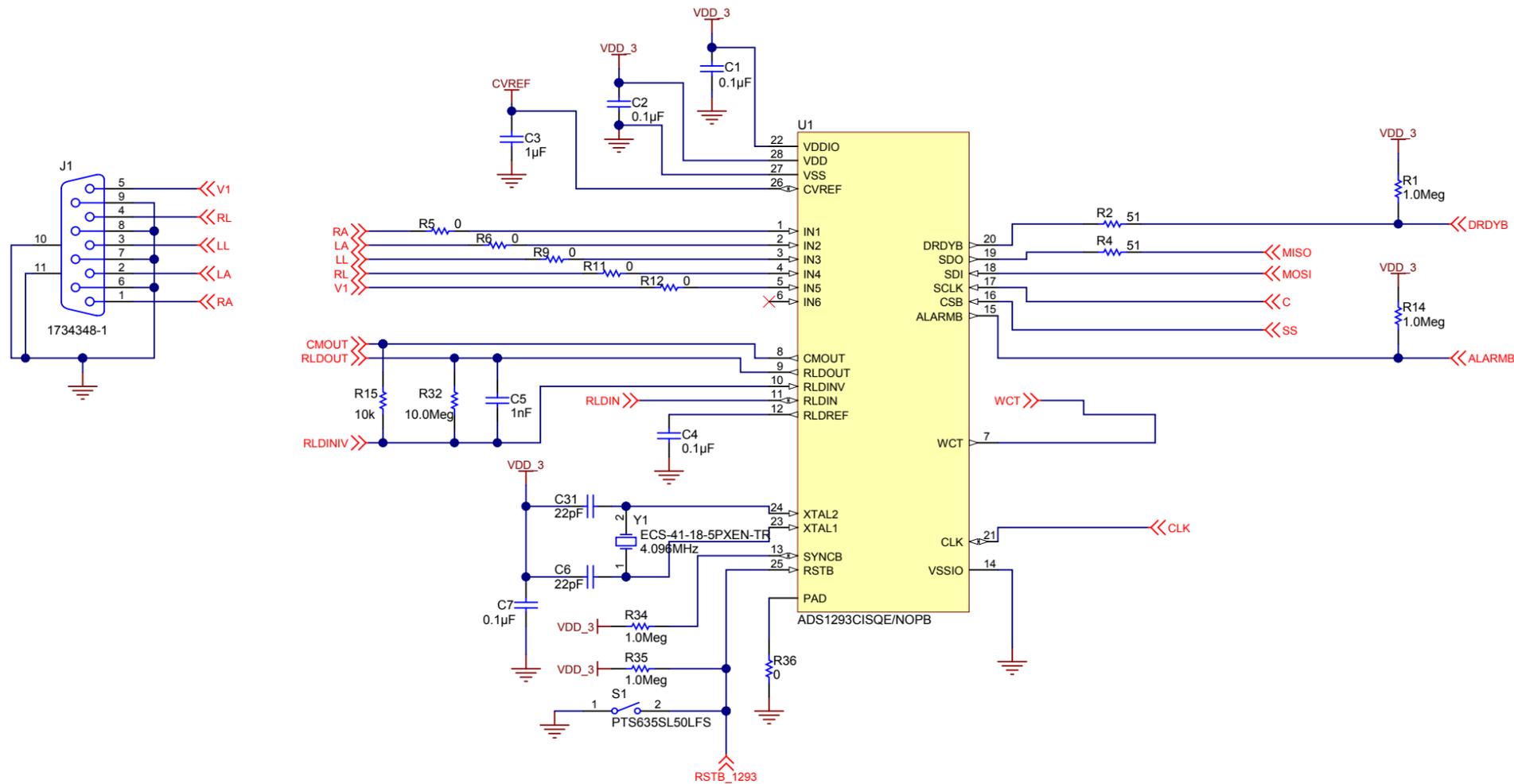
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Number: SAT0015	Rev: E2	Designed for: Public Release	Mod. Date: 1/21/2014
SVN Rev: Not in version control	Project Title: SAT0015_E2	Sheet Title: CC2541A	
Drawn By: Ajinder Singh	Assembly Variant: 001	Sheet: 1 of 1	
Engineer: Ajinder Singh	File: CC2541A.SchDoc	Size: B	
	Contact: http://www.ti.com/support		



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ADS1293 Analog Front End Section



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Number: SAT0015	Rev: E2	Designed for: Public Release	Mod. Date: 12/13/2013
SVN Rev: Not in version control	Project Title: SAT0015_E2	Sheet Title: ADS1293	Sheet: 1 of 1
Drawn By: Ajinder Singh	Assembly Variant: 001	File: ADS1293.SchDoc	Size: B
Engineer: Ajinder Singh	Contact: http://www.ti.com/support		



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